



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No.	10/622,346	Confirmation No.	4811
First Inventor	Sirinorakul	Filing Date	07/19/2003
Tech. Center/ Art Unit	2811	Examiner	Douglas W. Owens
Title:	Semiconductor Package Including Leadframe Roughened Using Chemical Etchant To Prevent Separation Between Leadframe And Molding Compound		
Docket No.:	NSE006 US	Customer No.:	34036

Santa Clara, California  
July 20, 2005

MAIL STOP RCE  
COMMISSIONER FOR PATENTS  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT**

Dear Sir:

In response to Office Action dated May 23, 2005, please amend the above-identified application as follows.

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 3 of this paper.

**Remarks/Arguments** begin on page 7 of this paper.